



MII 300-12 A4

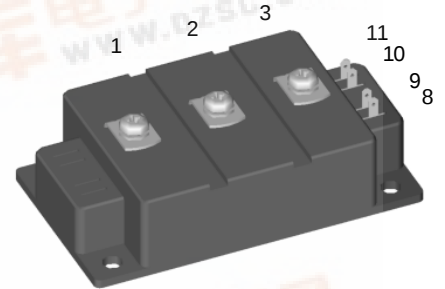
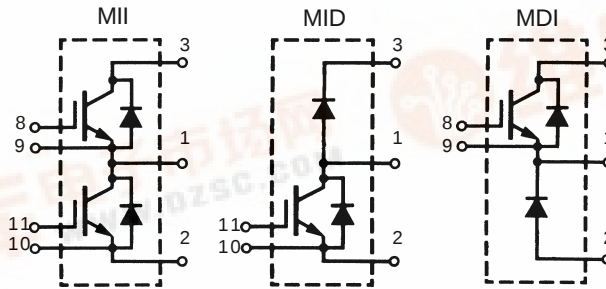
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IGBT Modules

Short Circuit SOA Capability
Square RBSOA

$$\begin{aligned} I_{C25} &= 330 \text{ A} \\ V_{CES} &= 1200 \text{ V} \\ V_{CE(sat) \text{ typ.}} &= 2.2 \text{ V} \end{aligned}$$



E 72873

Symbol	Conditions	Maximum Ratings	
V_{CES}	$T_J = 25^\circ\text{C to } 150^\circ\text{C}$	1200	V
V_{CGR}	$T_J = 25^\circ\text{C to } 150^\circ\text{C}; R_{GE} = 20 \text{ k}\Omega$	1200	V
V_{GES}	Continuous	± 20	V
V_{GEM}	Transient	± 30	V
I_{C25}	$T_C = 25^\circ\text{C}$	330	A
I_{C80}	$T_C = 80^\circ\text{C}$	220	A
I_{CM}	$T_C = 80^\circ\text{C}, t_p = 1 \text{ ms}$	440	A
t_{SC} (SCSOA)	$V_{GE} = \pm 15 \text{ V}, V_{CE} = V_{CES}, T_J = 125^\circ\text{C}$ $R_G = 3.3 \Omega$, non repetitive	10	μs
RBSOA	$V_{GE} = \pm 15 \text{ V}, T_J = 125^\circ\text{C}, R_G = 3.3 \Omega$ Clamped inductive load, $L = 100 \mu\text{H}$	$I_{CM} = 400$ $V_{CEK} \leq V_{CES}$	A
P_{tot}	$T_C = 25^\circ\text{C}$	1380	W
T_J		150	$^\circ\text{C}$
T_{stg}		-40 ... +150	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS $t = 1 \text{ min}$ $I_{ISOL} \leq 1 \text{ mA}$ $t = 1 \text{ s}$ Insulating material: Al_2O_3	4000 4800	V~ V~
M_d	Mounting torque (module) (terminals)	2.25-2.75 20-25 2.5-3.7 22-33	Nm lb.in. Nm lb.in.
d_s	Creepage distance on surface	10	mm
d_A	Strike distance through air	9.6	mm
a	Max. allowable acceleration	50	m/s^2
Weight	Typical	250 8.8	g oz.

Features

- NPT IGBT technology
- low saturation voltage
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- ultra fast free wheeling diodes
- package with DCB ceramic base plate
- isolation voltage 4800 V
- UL registered E72873

Advantages

- space and weight savings
- reduced protection circuits

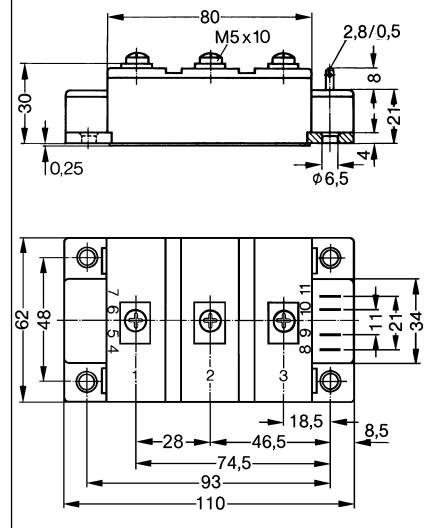
Typical Applications

- AC and DC motor control
- AC servo and robot drives
- power supplies
- welding inverters

Data according to a single IGBT/FRED unless otherwise stated.

Symbol	Conditions	Characteristic Values (T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
V _{(BR)CES}	V _{GE} = 0 V	1200		V
V _{GE(th)}	I _C = 8 mA, V _{CE} = V _{GE}	4.5		6.5 V
I _{CES}	V _{CE} = V _{CES} T _J = 25°C T _J = 125°C		20	13 mA mA
I _{GES}	V _{CE} = 0 V, V _{GE} = ±20 V			±800 nA
V _{CE(sat)}	I _C = 200 A, V _{GE} = 15 V		2.2	2.7 V
C _{ies}	V _{CE} = 25 V, V _{GE} = 0 V, f = 1 MHz		13	nF
C _{oes}			2	nF
C _{res}			1	nF
t _{d(on)}	Inductive load, T _J = 125°C I _C = 200 A, V _{GE} = ±15 V V _{CE} = 600 V, R _G = 3.3 Ω		100	ns
t _r			60	ns
t _{d(off)}			600	ns
t _f			90	ns
E _{on}			32	mJ
E _{off}			29	mJ
R _{thJC}	with heatsink compound			0.09 K/W
R _{thJS}			0.18	K/W

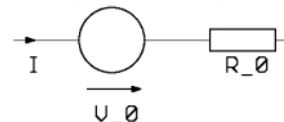
Dimensions in mm (1 mm = 0.0394")



Reverse Diode (FRED)	Conditions	Characteristic Values (T _J = 25°C, unless otherwise specified)		
		min.	typ.	max.
V _F	I _F = 200 A, V _{GE} = 0 V, I _F = 200 A, V _{GE} = 0 V, T _J = 125°C		2.2 1.7	2.5 V V
I _F	T _C = 25°C T _C = 80°C			450 A 280 A
I _{RM}	I _F = 200 A, V _{GE} = 0 V, -di _F /dt = 1800 A/μs		180	A
t _{rr}	T _J = 125°C, V _R = 600 V		200	ns
R _{thJC}	with heatsink compound			0.15 K/W
R _{thJS}			0.3	K/W

Equivalent Circuits for Simulation

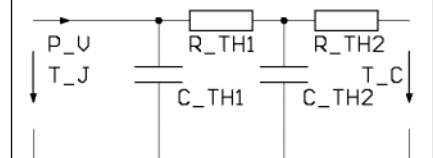
Conduction



IGBT (typ. at V_{GE} = 15 V; T_J = 125°C)
V₀ = 1.3 V; R₀ = 6.2 mΩ

Free Wheeling Diode (typ. at T_J = 125°C)
V₀ = 1.3 V; R₀ = 2.4 mΩ

Thermal Response



IGBT (typ.)
C_{th1} = 0.50 J/K; R_{th1} = 0.088 K/W
C_{th2} = 1.16 J/K; R_{th2} = 0.002 K/W

Free Wheeling Diode (typ.)
C_{th1} = 0.44 J/K; R_{th1} = 0.146 K/W
C_{th2} = 0.80 J/K; R_{th2} = 0.003 K/W

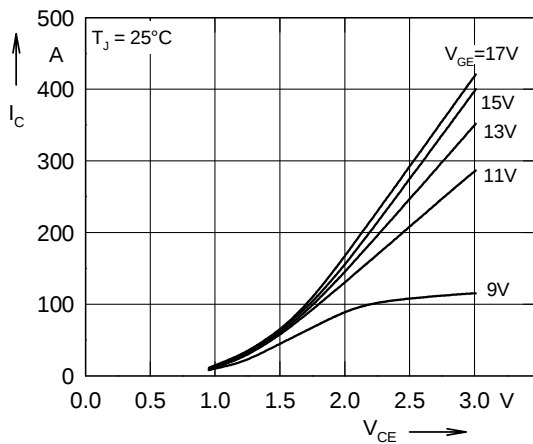


Fig. 1 Typ. output characteristics

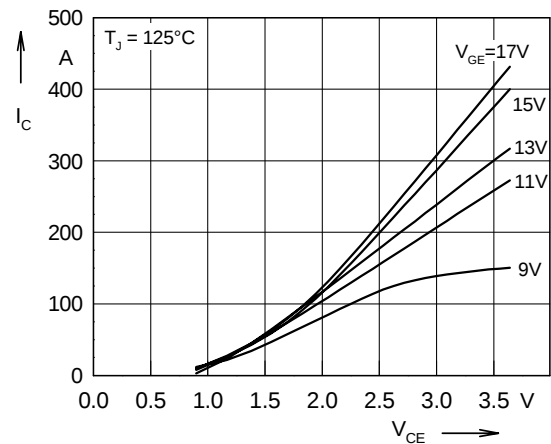


Fig. 2 Typ. output characteristics

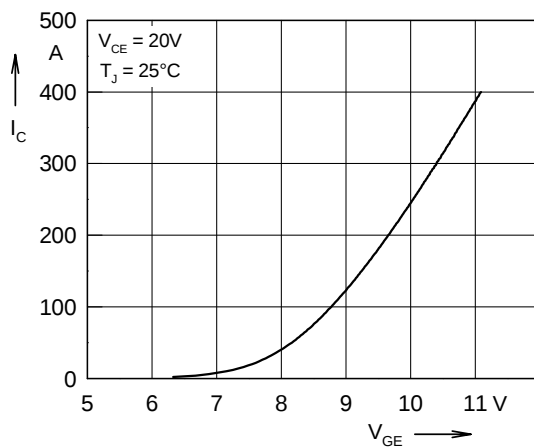


Fig. 3 Typ. transfer characteristics

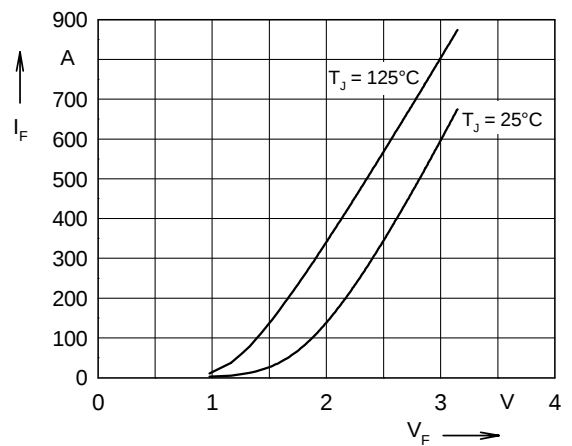


Fig. 4 Typ. forward characteristics of free wheeling diode

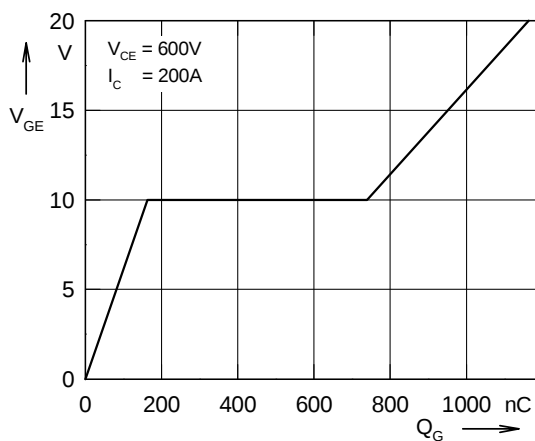


Fig. 5 Typ. turn on gate charge

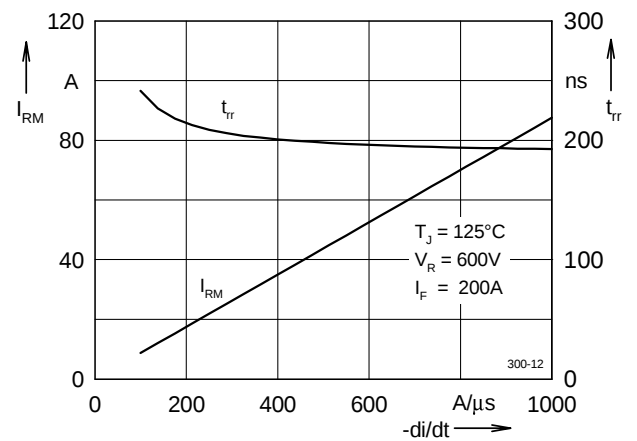


Fig. 6 Typ. turn off characteristics of free wheeling diode

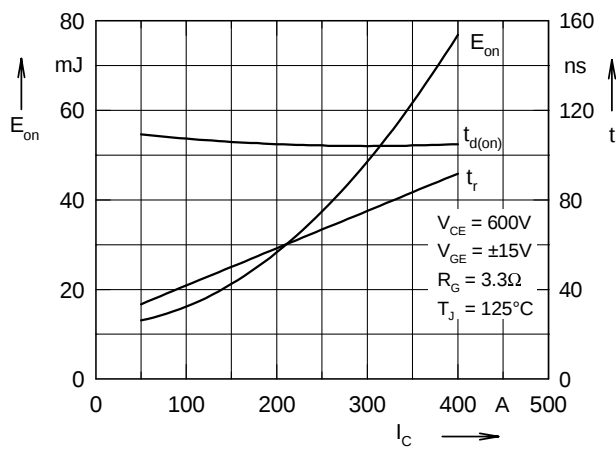


Fig. 7 Typ. turn on energy and switching times versus collector current

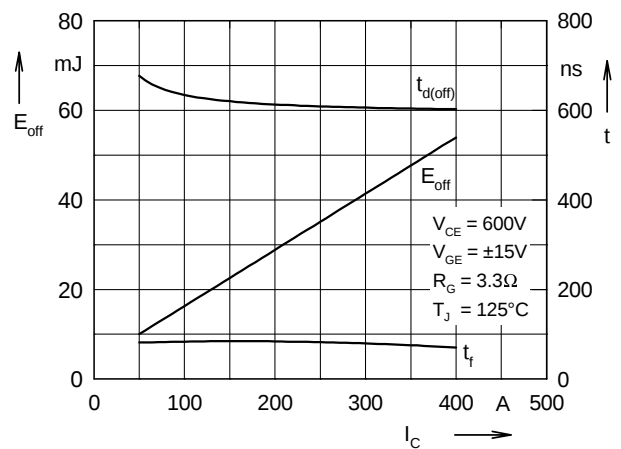


Fig. 8 Typ. turn off energy and switching times versus collector current

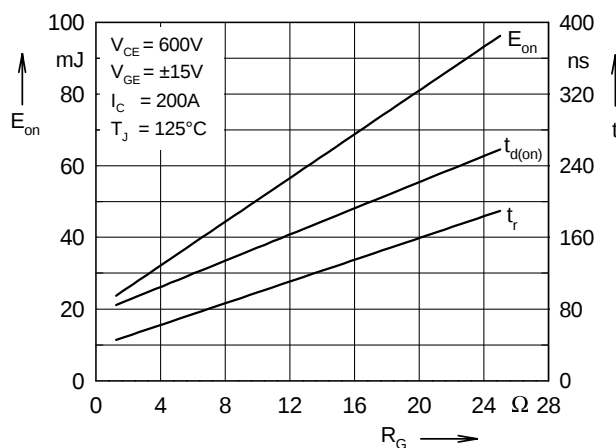


Fig. 9 Typ. turn on energy and switching times versus gate resistor

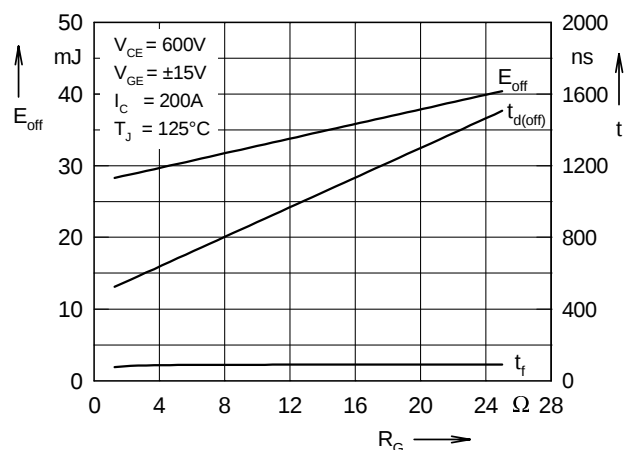


Fig. 10 Typ. turn off energy and switching times versus gate resistor

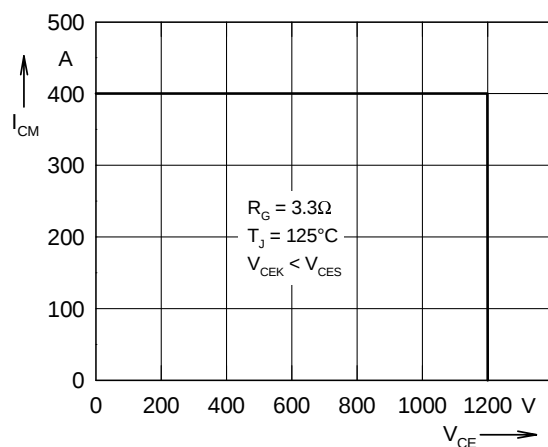


Fig. 11 Reverse biased safe operating area RBSOA

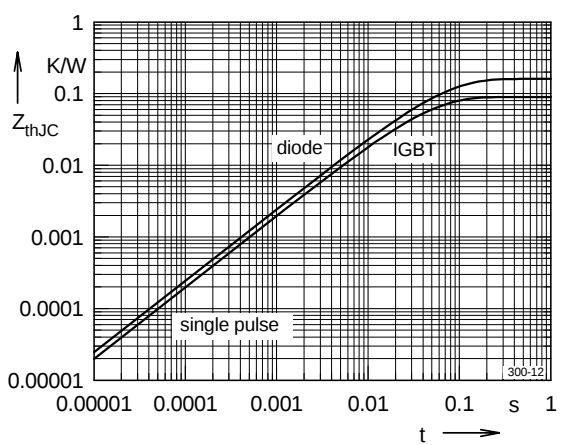


Fig. 12 Typ. transient thermal impedance